

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of:	§	
Ling Chen et al.	§	
	§	Group Art Unit: 2823
Serial No.: 10/741,824	§	
	§	
Confirmation No.: 2621	§	
	§	Examiner: John M. Parker
Filed: December 19, 2003	§	
	§	
For: Enhancement of CU Line	§	
Reliability Using Thin ALD Tan	§	
Film to Cap the CU Line	§	

MAIL STOP AF  
 Commissioner for Patents  
 P.O. Box 1450  
 Alexandria, VA 22313-1450

Dear Sir:

**RESPONSE TO FINAL OFFICE ACTION DATED OCTOBER 03, 2006**

In response to the Final Office Action dated October 3, 2006, having a shortened statutory period for response set to expire on January 3, 2007, please enter this response and reconsider the claims pending in the application for the reasons discussed below. Although Applicants believe that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/007532/KMT for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 7 of this paper.